| e. | Docket | No. | |
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Declaration for U.S. Patent Application

| | | | • • | | |
|---|---|--|---|--|--|
| As a below name | ed inventor, I hereby declare the | at: | | | |
| My residence, po | st office address and citizensh | ip are as stated below r | ext to my name. | | |
| names are listed l | | hich is claimed and for | listed below) or an original, first and jo which a patent is sought on the invent BLE MAIN SPINDLE | | |
| the specification | of which is attached hereto unl | less the following is ch | ecked | | |
| - | none Clad on | TT-:4 | 1 Cartes Amelication Number | | |
| was filed on as United States App PCT International Application Number (if applicable). | | | and was amended on | Application Number or and was amended on | |
| | t I have reviewed and understa amendment referred to above. | nd the contents of the a | above-identified specification, includir | ig the claim(s), as | |
| I acknowledge th § 1.56. | e duty to disclose information | which is material to par | tentability as defined in Title 37, Code | of Federal Regulations, | |
| inventor's certific | | identified below any fo | ode, § 119 (a) - (d) of any foreign apporeign application for patent or inventor | | |
| (List prior | JP2002-280411 | <u>Japan</u> | 26 <u>/September/200</u> 2 | Priority Claimed X Yes No | |
| foreign applications. | (Number) | (Country) | (Day/Month/Year Filed) | Yes No | |
| See note A on back of this | (Number) | (Country) | (Day/Month/Year Filed) | Yes No | |
| page) | (Number) | (Country) | (Day/Month/Year Filed) | Yes No | |
| | (Number) | (Country) | (Day/Month/Year Filed) | | |
| (See note B on ba | ack of this page) | See attached list for ac | Iditional prior foreign applications | | |
| subject matter of the first paragraph as defined in Title | each of the claims of this applin of Title 35, United States Code | cation is not disclosed e, § 112, I acknowledge ons, § 1.56 which beca | any United States application(s) listed in the prior United States application i the duty to disclose information which me available between the filing date o | in the manner provided by is material to patentability | |
| (List Prior U.S. | | | | · . | |
| Applications) | (Appln. Serial No.) | (Filing Date) | (Status: Patented, Pending, Aba | indoned) | |
| | (Appln. Serial No.) | (Filing Date) | (Status: Patented, Pending, Aba | indoned) | |
| | (Appln. Serial No.) | (Filing Date) | (Status: Patented, Pending, Aba | andoned) | |
| | | | | | |

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



Please direct all communications to the following address:



PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| (See note C | | ne, family name) <u>Takashi SHIMADA</u> | | | | |
|---------------------------|--|---|--|--|--|--|
| above) | Inventor's signature Takashi Shi | nada Date September 16, 2003 | | | | |
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| Full name of sixth | inventor (given name, family name) | | | | | |
| Inventor's signature | e | Date | | | | |
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| Post Office Addres | SS | | | | | |
| Full name of seven | th inventor (given name, family name) | | | | | |
| Inventor's signature | e | Date | | | | |
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| Post Office Addres | SS | | | | | |
| Rev. 11/00 | | | | | | |

NOTES

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.